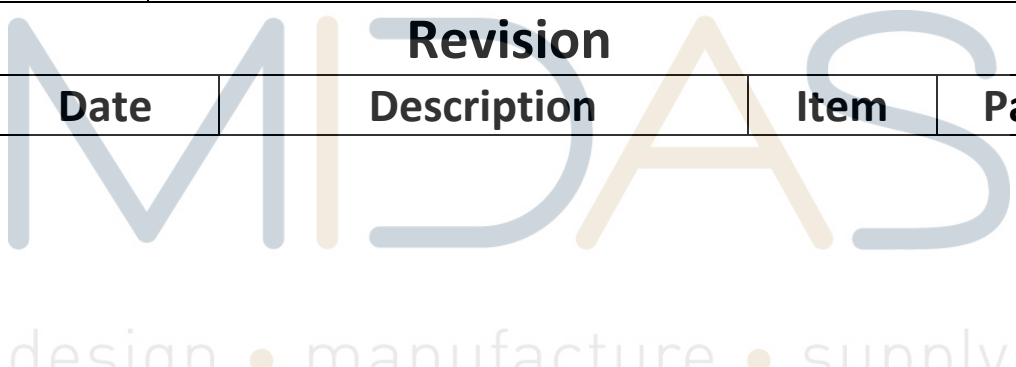


<b>Specification</b>				
<b>Part Number:</b>	<b>MC22405C6WK-SPR</b>			
<b>Version:</b>	1			
<b>Date:</b>	17/06/2011			
<b>Revision</b>				
<b>No.</b>	<b>Date</b>	<b>Description</b>	<b>Item</b>	<b>Page</b>
				

## BOOKBINDING AREA

DOC.

DATASHEET STATEMENT

1. The following icons are absolutely designed by Midas independently in 2007-SEP. They are not in common use in the LCD industry yet but just used for marking out Midas products' characteristics quickly and simply without any special meaning. Midas reserves the composing right and copyright. No one else is allowed to adopt these icons without Midas approval.
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4. As the difference in test standard and test conditions, also Midas insufficient familiarity with the actual LCD using environment, all the referred information in this DATASHEET (including the icons) only have two functions:  
4.1: providing quick reference when you are judging whether or not the product meets your requirements.  
4.2: listing out definitely the tolerance.

SAMPLE APPROVAL document rather than consider this DATASHEET as the standard for judging whether or not the LCD meets your requirements. Once you instruct Midas to a mass-production without definite demand for providing sample before, Midas will disclaim all responsibility if the mass-production is proved not meeting with your requirements.

5. The sequence of the icons is random and doesn't indicate the importance grade.
6. Icons explanation

Midas 2006 version logo. Midas is an integrated manufacturer of flat panel display (FPD). Midas supplies TN, HTN, STN, FSTN monochrome LCD panel; COB, COG, TAB LCD module; and all kinds of LED backlight.



### FAST RESPONSE TIME

This icon on the cover indicates the product is with high response speed; Otherwise not.



### PROTECTION CIRCUIT

This icon on the cover indicates the product is with protection circuit; Otherwise not.



### HIGH CONTRAST

This icon on the cover indicates the product is with high contrast; Otherwise not.



### LONG LIFE VERSION

This icon on the cover indicates the product is long life version (over 9K hours guaranteed); Otherwise not.



### WIDE VIEWING SCOPE

This icon on the cover indicates the product is with wide viewing scope; Otherwise not.



### Anti UV VERSION

This icon on the cover indicates the product is against UV line. Otherwise not.



### RoHS COMPLIANCE

This icon on the cover indicates the product meets ROHS requirements; Otherwise not.



### OPERATION TEMPERATURE RANGE

This icon on the cover indicates the operating temperature range (X-Y).



### 3TIMES 100% QC EXAMINATION

This icon on the cover indicates the product has passed Midas thrice 100% QC. Otherwise not.



### TWICE SELECTION OF LED MATERIALS

This icon on the cover indicates the LED had passed Midas twice strict selection which promises the product's identical color and brightness; Otherwise not.



### V<sub>ICM</sub> = 3.0V

This icon on the cover indicates the product can work at 3.0V exactly; otherwise not.



### N SERIES TECHNOLOGY (2008 developed)

New structure, new craft, new technology and new materials inside both LCD module and LCD panel to improve the "RainBow"

# MC22405C6WK-SPTLY

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3.	<i>Module Classification Information</i>	<i>Page 5</i>
4.	<i>Interface Pin Function</i>	<i>Page 6</i>
5.	<i>Contour Drawing &amp; Block Diagram</i>	<i>Page 7</i>
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design • manufacture • supply

## 2. General Specification

The Features of the Module is description as follow:

- Module dimension: 118.0 x 36.0 x 13.6 (max.) mm<sup>3</sup>
- View area: 94.5 x 16.0 mm<sup>2</sup>
- Active area: 88.3 x 11.5 mm<sup>2</sup>
- Number of Characters: 24 characters x 2 Lines
- Dot size: 0.6 x 0.65 mm<sup>2</sup>
- Dot pitch: 0.65 x 0.70 mm<sup>2</sup>
- Character size: 3.2 x 5.55 mm<sup>2</sup>
- Character pitch: 3.7 x 5.95 mm<sup>2</sup>
- LCD type: STN Positive, Yellow Green Tgreflective
- Duty: 1/16
- View direction: 6 o' clock

MIDAS  
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# Midas LCD Part Number System

**MC COG 132033 A \* 6 W \* \* - S N T L W \* \***  
**1 2 3 4 5 6 7 8 9 - 10 11 12 13 14 15 16**

- 1 = **MC:** Midas Components
- 2 = **Blank:** COB (chip on board) **COG:** chip on glass
- 3 = **No of dots** (e.g. 240064 = 240 x 64 dots) (e.g. 21605 = 2 x 16 5mm C.H.)
- 4 = **Series**
- 5 = **Series Variant:** A to Z – see addendum
- 6 = **3:** 3 o'clock **6:** 6 o'clock **9:** 9 o'clock **12:** 12 o'clock
- 7 = **S:** Normal (0 to + 50 deg C) **W:** Wide temp. (-20 to + 70 deg C) **X:** Extended temp (-30 + 80 Deg C)
- 8 = **Character Set**

**Blank:** Standard (English/Japanese)  
**C:** Chinese Simplified (Graphic Displays only)  
**CB:** Chinese Big 5 (Graphic Displays only)  
**H:** Hebrew  
**K:** European (std) (English/German/French/Greek)  
**L:** English/Japanese (special)  
**M:** European (English/Scandinavian)  
**R:** Cyrillic  
**W:** European (English/Greek)  
**U:** European (English/Scandinavian/Icelandic)

9 = **Bezel Height** (where applicable /available)

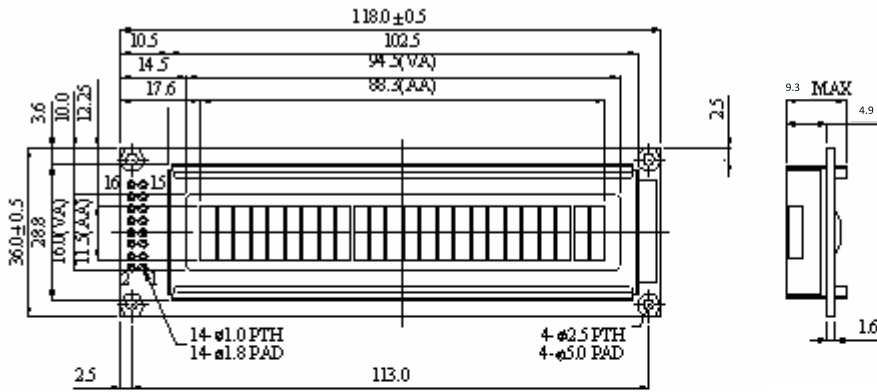
	Top of Bezel to Top of PCB	LED Connection Common (via pins 1 and 2) via pins 15+ 16-	Array or Edge Lit
<b>Blank</b>	9.5mm / not applicable		Array
<b>2</b>	8.9 mm	Common	Array
<b>3</b>	7.8 mm	Separate	Array
<b>4</b>	7.8 mm	Common	Array
<b>5</b>	9.5 mm	Separate	Array
<b>6</b>	7 mm	Common	Array
<b>7</b>	7 mm	Separate	Array
<b>8</b>	6.4 mm	Common	Edge
<b>9</b>	6.4 mm	Separate	Edge
<b>A</b>	5.5 mm	Common	Edge
<b>B</b>	5.5 mm	Separate	Edge
<b>D</b>	6.0mm	Separate	Edge
<b>E</b>	5.0mm	Separate	Edge
<b>F</b>	4.7mm	Common	Edge
<b>G</b>	3.7mm	Separate	EL
<b>H</b>	7 mm	Separate	Edge

- 10 = **T:** TN **S:** STN **B:** STN Blue **G:** STN Grey **F:** FSTN **F2:** FFSTN **V:** VA (Vertically Aligned)
- 11 = **P:** Positive **N:** Negative
- 12 = **R:** Reflective **M:** Transmissive **T:** Transflective
- 13 = **Backlight:** **Blank:** Reflective **L:** LED
- 14 = **Backlight Colour:** **Y:** Yellow-Green **W:** White **B:** Blue **R:** Red **A:** Amber **O:** Orange **G:** Green **RGB:** R.G.B.
- 15 = **Driver Chip:** **Blank:** Standard **I:** I<sup>2</sup>C **S:** SPI **T:** Toshiba T6963C **A:** Avant SAP1024B **R:** Raio RA6963
- 16 = **Voltage Variant:** e.g. **3** = 3v

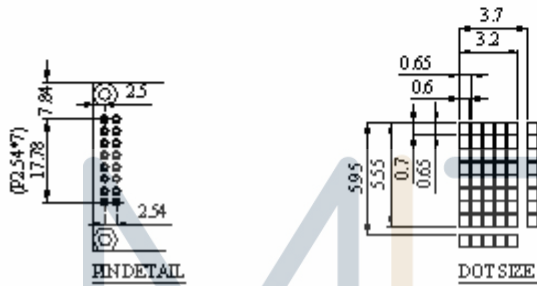
## 4. Interface Pin Function

Pin No.	Symbol	Level	Description
1	V <sub>SS</sub>	0V	Ground
2	V <sub>DD</sub>	5.0V	Supply Voltage for logic
3	VO	(Variable)	Operating voltage for LCD
4	RS	H/L	H: DATA, L: Instruction code
5	R/W	H/L	H: Read(MPU→Module) L: Write(MPU→Module)
6	E	H,H→L	Chip enable signal
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	Data bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	Data bus line
12	DB5	H/L	Data bus line
13	DB6	H/L	Data bus line
14	DB7	H/L	Data bus line
15	A	—	PE
16	K	—	PE

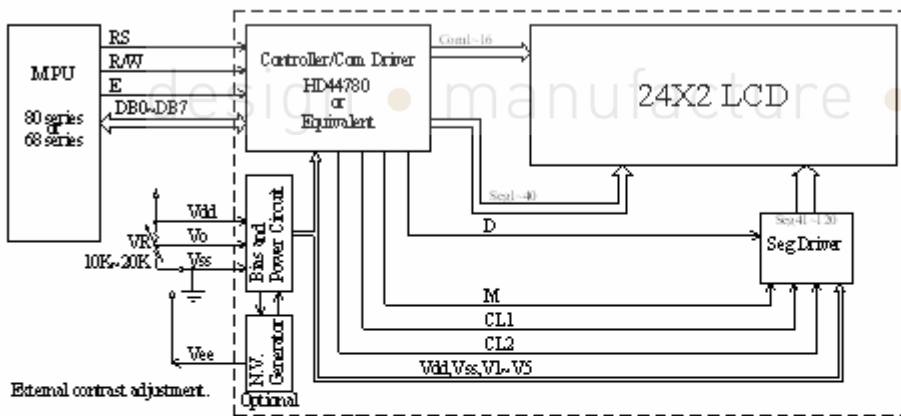
# 5. Contour Drawing & Block Diagram



Pin No.	Symbol
1	V <sub>SS</sub>
2	V <sub>DD</sub>
3	V <sub>O</sub>
4	RS
5	R/W
6	E
7	DB0
8	DB1
9	DB2
10	DB3
11	DB4
12	DB5
13	DB6
14	DB7
15	NC
16	NC



The non-specified tolerance of dimension is  $\pm 0.3\text{mm}$ .



Character located	1	2	3	4	5	6	-----	19	20	21	22	23	24
DDRAM address	00	01	02	03	04	05	-----	12	13	14	15	16	17
DDRAM address	40	41	42	43	44	45	-----	52	53	54	55	56	57

## 6. Function Description

The LCD display Module is built in a LSI controller, the controller has two 8-bit registers, an instruction register (IR) and a data register (DR).

The IR stores instruction codes, such as display clear and cursor shift, and address information for display data RAM (DDRAM) and character generator (CGRAM). The IR can only be written from the MPU. The DR temporarily stores data to be written or read from DDRAM or CGRAM. When address information is written into the IR, then data is stored into the DR from DDRAM or CGRAM. By the register selector (RS) signal, these two registers can be selected.

RS	R/W	Operation
0	0	IR write as an internal operation (display clear, etc.)
0	1	Read busy flag (DB7) and address counter (DB0 to DB7)
1	0	Write data to DDRAM or CGRAM (DR to DDRAM or CGRAM)
1	1	Read data from DDRAM or CGRAM (DDRAM or CGRAM to DR)

### Busy Flag (BF)

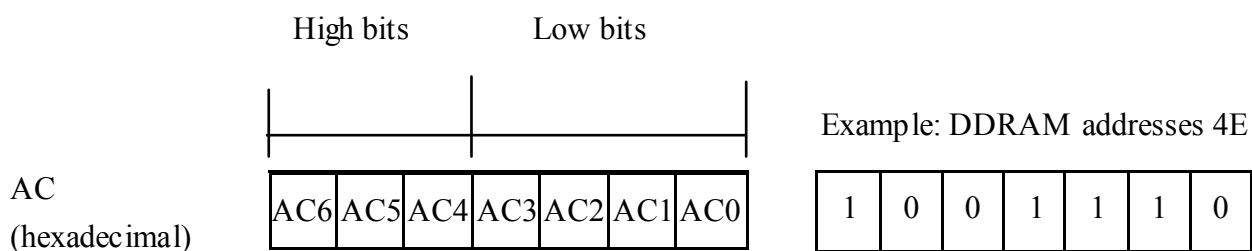
When the busy flag is 1, the controller LSI is in the internal operation mode, and the next instruction will not be accepted. When RS=0 and R/W=1, the busy flag is output to DB7. The next instruction must be written after ensuring that the busy flag is 0.

### Address Counter (AC)

The address counter (AC) assigns addresses to both DDRAM and CGRAM.

### Display Data RAM (DDRAM)

This DDRAM is used to store the display data represented in 8-bit character codes. Its extended capacity is 80×8 bits or 80 characters. Below figure is the relationships between DDRAM addresses and positions on the liquid crystal display.





Display position DDRAM address

1	2	3	4	5	6	7	.....	21	22	23	24			
00	01	02	03	04	05	06					14	15	16	17
40	41	42	43	44	45	46					54	55	56	57

2-Line by 24-Character Display

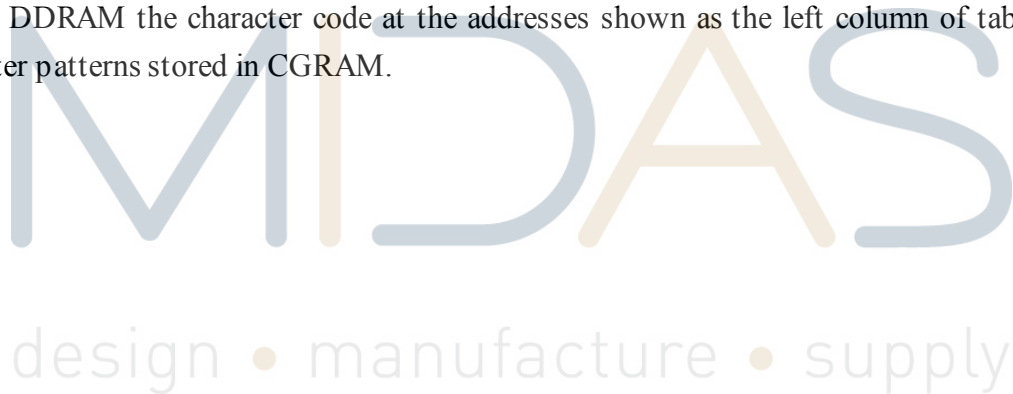
**Character Generator ROM (CGROM)**

The CGROM generate 5×8 dot or 5×10 dot character patterns from 8-bit character codes. See Table 2.

**Character Generator RAM (CGRAM)**

In CGRAM, the user can rewrite character by program. For 5×8 dots, eight character patterns can be written, and for 5×10 dots, four character patterns can be written.

Write into DDRAM the character code at the addresses shown as the left column of table 1. To show the character patterns stored in CGRAM.



# Relationship between CGRAM Addresses, Character Codes (DDRAM) and Character patterns

**Table 1.**

For 5 \* 8 dot character patterns

Character Codes ( DDRAM data )								CGRAM Address					Character Patterns ( CGRAM data )															
7	6	5	4	3	2	1	0	5		4			3		2		1		0		7	6	5	4	3	2	1	0
High				Low				High		Low			High				Low											
0 0 0 0 * 0 0 0								0 0 0					0	0	0					*	*	*					Character pattern ( 1 )	
													0	0	1					*	*	*	0 0 0					
													0	1	0					*	*	*	0 0 0					
													0	1	1					*	*	*	0					
													1	0	0					*	*	*	0 0 0					
													1	0	1					*	*	*	0 0 0					
													1	1	0					*	*	*	0 0 0					
													1	1	1					*	*	*	0 0 0 0 0					
													0	0	0					*	*	*	0 0 0					
													0	0	1					*	*	*	0 0 0					
0 0 0 0 * 0 0 1								0 0 1					0	0	1					*	*	*					Character pattern ( 2 )	
													0	1	0					*	*	*	0 0 0					
													0	1	1					*	*	*	0 0 0					
													1	0	0					*	*	*	0 0 0					
													1	0	1					*	*	*	0 0 0					
													1	1	0					*	*	*	0 0 0 0 0					
													1	1	1					*	*	*	0 0 0 0 0					
													0	0	0					*	*	*	0 0 0 0 0					
													0	0	1					*	*	*	0 0 0 0 0					
													0	1	0					*	*	*	0 0 0 0 0					
0 0 0 0 * 1 1 1								1 1 1					1	0	0					*	*	*					Cursor pattern	
													1	0	1					*	*	*						
													1	1	0					*	*	*						
													1	1	1					*	*	*						

For 5 \* 10 dot character patterns

Character Codes ( DDRAM data )										CGRAM Address					Character Patterns ( CGRAM data )																			
7	6	5	4	3	2	1	0	5		4			3		2		1		0		7	6	5	4	3	2	1	0						
High					Low					High		Low			High					Low														
0 0 0 0 * 0 0 0										0 0					0	0	0	0						*	*	*	0 0 0 0 0					Character pattern		
															0	0	0	1						*	*	*	0 0 0 0 0							
															0	0	1	0						*	*	*	0 0 0 0 0							
															0	0	1	1						*	*	*	0 0 0							
															0	1	0	0						*	*	*	0 0 0							
															0	1	0	1						*	*	*	0 0 0 0							
															0	1	1	0						*	*	*	0 0 0 0							
															0	1	1	1						*	*	*	0 0 0 0 0							
															1	0	0	0						*	*	*	0 0 0 0 0							
															1	0	0	1						*	*	*	0 0 0 0 0							
															1	0	1	0						*	*	*	0 0 0 0 0					Cursor pattern		
															1	0	1	1						*	*	*								
															1	1	1	1						*	*	*								
															1	1	1	1						*	*	*								

■ : " High "

# 7. Character Generator ROM Pattern

Table 2.

Upper 4 bit Lower 4 bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH	HLLL	HLLH	HLHL	HLHH	HHLL	HHLH	HHHL	HHHH
LLLL	CG RAM (1)	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E
LLLH	CG RAM (2)	F	10	11	12	13	14	15	16	17	18	19	20	21	22	23
LLHL	CG RAM (3)	24	25	26	27	28	29	30	31	32	33	34	35	36	37	38
LLHH	CG RAM (4)	39	40	41	42	43	44	45	46	47	48	49	50	51	52	53
LHLL	CG RAM (5)	54	55	56	57	58	59	60	61	62	63	64	65	66	67	68
LHLH	CG RAM (6)	69	70	71	72	73	74	75	76	77	78	79	80	81	82	83
LHHL	CG RAM (7)	84	85	86	87	88	89	90	91	92	93	94	95	96	97	98
LHHH	CG RAM (8)	99	100	101	102	103	104	105	106	107	108	109	110	111	112	113
HLLL	CG RAM (1)	114	115	116	117	118	119	120	121	122	123	124	125	126	127	128
HLLH	CG RAM (2)	129	130	131	132	133	134	135	136	137	138	139	140	141	142	143
HLHL	CG RAM (3)	144	145	146	147	148	149	150	151	152	153	154	155	156	157	158
HLHH	CG RAM (4)	159	160	161	162	163	164	165	166	167	168	169	170	171	172	173
HHLL	CG RAM (5)	174	175	176	177	178	179	180	181	182	183	184	185	186	187	188
HHLH	CG RAM (6)	189	190	191	192	193	194	195	196	197	198	199	200	201	202	203
HHHL	CG RAM (7)	204	205	206	207	208	209	210	211	212	213	214	215	216	217	218
HHHH	CG RAM (8)	219	220	221	222	223	224	225	226	227	228	229	230	231	232	233

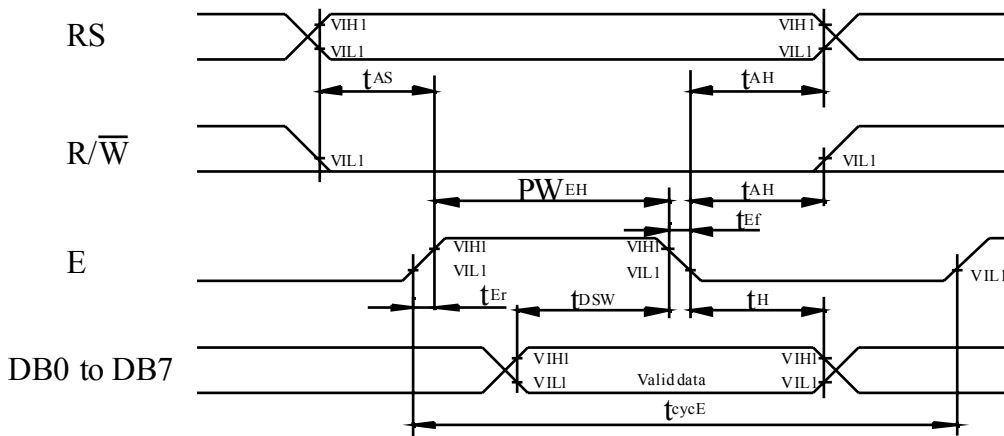
## 8. Instruction Table

Instruction	Instruction Code										Description	Execution time (fosc=270Khz)		
	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0				
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "00H" to DDRAM and set DDRAM address to "00H" from AC	1.53 ms		
Return Home	0	0	0	0	0	0	0	0	0	1	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.53 ms		
Entry Mode Set	0	0	0	0	0	0	0	0	1	I/D	SH	Assign cursor moving direction and enable the shift of entire display.	39 $\mu$ s	
Display ON/OFF Control	0	0	0	0	0	0	0	1	D	C	B	Set display (D), cursor (C), and blinking of cursor (B) on/off control bit.	39 $\mu$ s	
Cursor or Display Shift	0	0	0	0	0	0	1	S/C	R/L	—	—	Set cursor moving and display shift control bit, and the direction, without changing of DDRAM data.	39 $\mu$ s	
Function Set	0	0	0	0	1	DL	N	F	—	—	—	Set interface data length (DL:8-bit/4-bit), numbers of display line (N:2-line/1-line) and, display font type (F:5×11 dots/5×8 dots)	39 $\mu$ s	
Set CGRAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	—	—	Set CGRAM address in address counter.	39 $\mu$ s
Set DDRAM Address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	—	—	Set DDRAM address in address counter.	39 $\mu$ s
Read Busy Flag and Address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	—	—	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0 $\mu$ s
Write Data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	—	—	Write data into internal RAM (DDRAM/CGRAM).	43 $\mu$ s
Read Data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	—	—	Read data from internal RAM (DDRAM/CGRAM).	43 $\mu$ s

\* "—" : don't care

## 9. Timing Characteristics

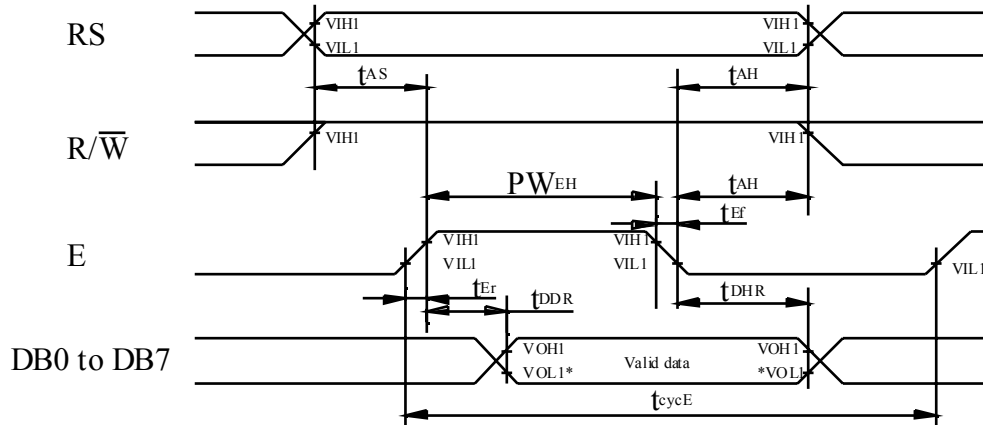
### 9.1 Write Operation



$T_a=25^{\circ}\text{C}$ ,  $V_{DD}=5.0\pm 0.5\text{V}$

Item	Symbol	Min	Typ	Max	Unit
Enable cycle time	$t_{cycE}$	1200	—	—	ns
Enable pulse width (high level)	$PW_{EH}$	140	—	—	ns
Enable rise/fall time	$t_{Er}, t_{Ef}$	—	—	25	ns
Address set-up time (RS, R/W to E)	$t_{AS}$	0	—	—	ns
Address hold time	$t_{AH}$	10	—	—	ns
Data set-up time	$t_{Dsw}$	40	—	—	ns
Data hold time	$t_H$	10	—	—	ns

## 9.2 Read Operation

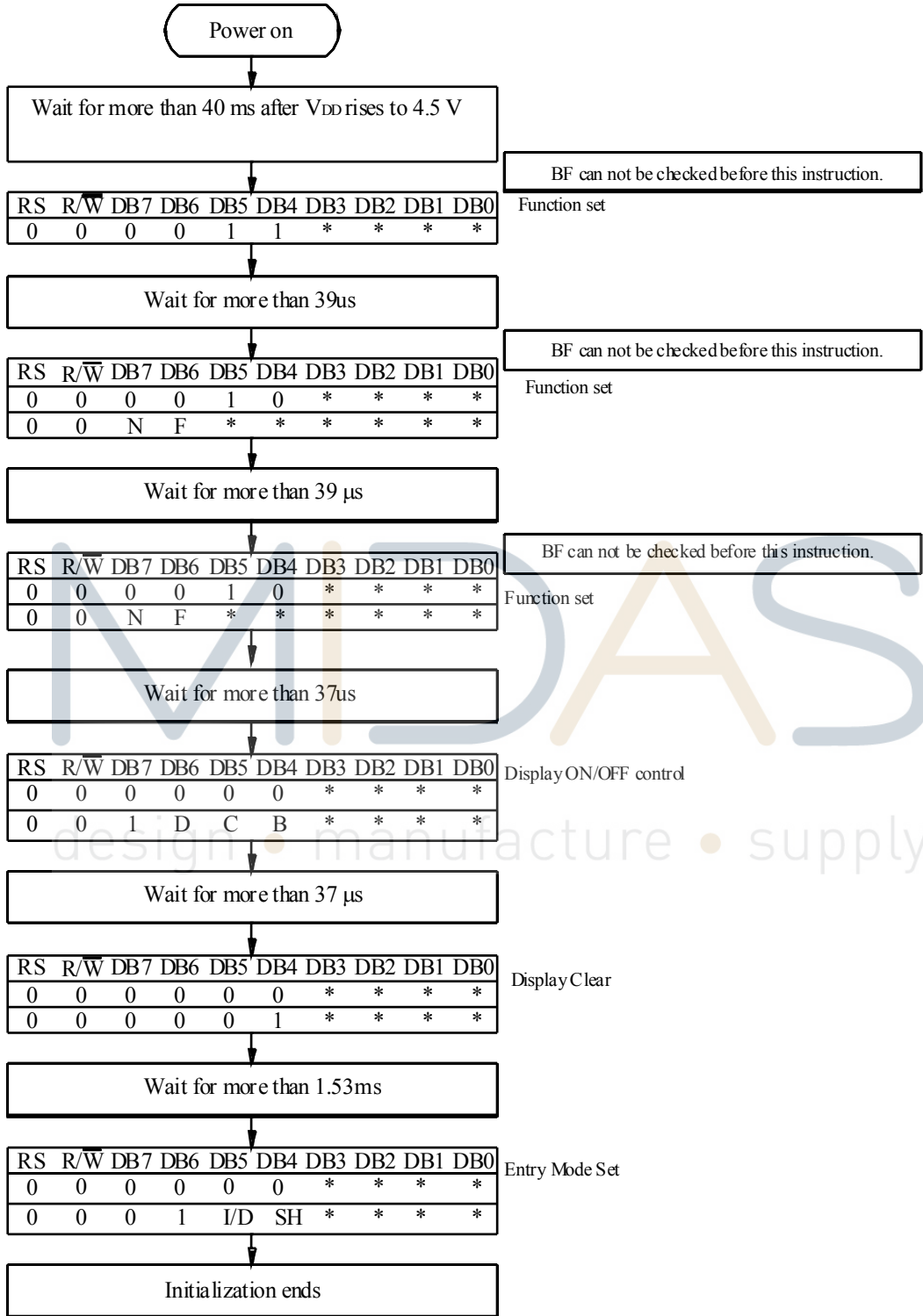


NOTE: \*VOL1 is assumed to be 0.8V at 2 MHz operation.

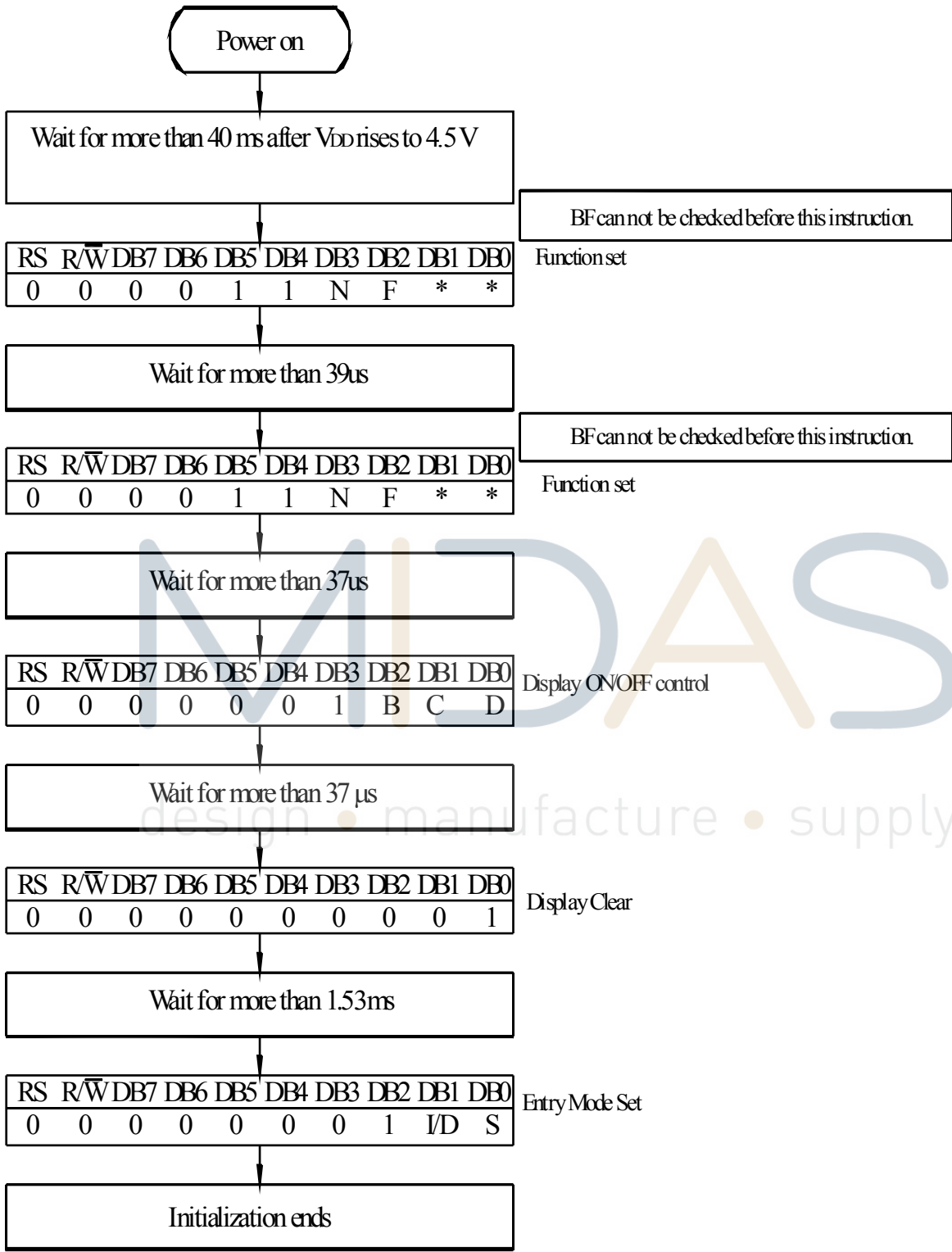
Ta=25°C, VDD=5.0± 0.5V

Item	Symbol	Min	Typ	Max	Unit
Enable cycle time	$t_{cycE}$	1200	—	—	ns
Enable pulse width (high level)	$PW_{EH}$	140	—	—	ns
Enable rise/fall time	$t_{Er}, t_{Ef}$	—	—	25	ns
Address set-up time (RS, R/W to E)	$t_{AS}$	0	—	—	ns
Address hold time	$t_{AH}$	10	—	—	ns
Data delay time	$t_{DDR}$	—	—	100	ns
Data hold time	$t_{DHR}$	10	—	—	ns

# 10. Initializing of LCM



4-Bit Ineterface



8-Bit Interface

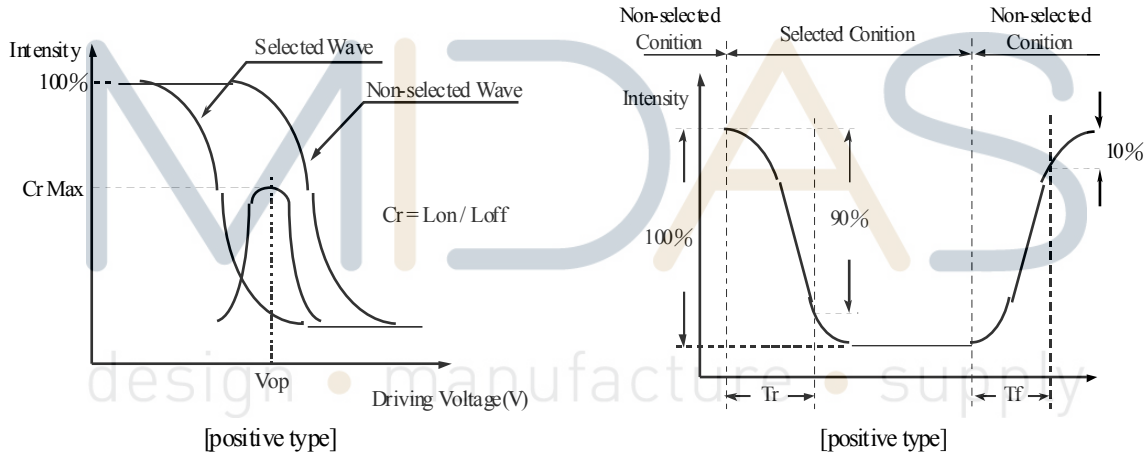


# 11. Optical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
View Angle	(V) $\theta$	$CR \geq 2$	20	—	40	deg
	(H) $\varphi$	$CR \geq 2$	-30	—	30	deg
Contrast Ratio	CR	—	—	3	—	—
Response Time	T rise	—	—	200	300	ms
	T fall	—	—	200	300	ms

### Definition of Operation Voltage (Vop)

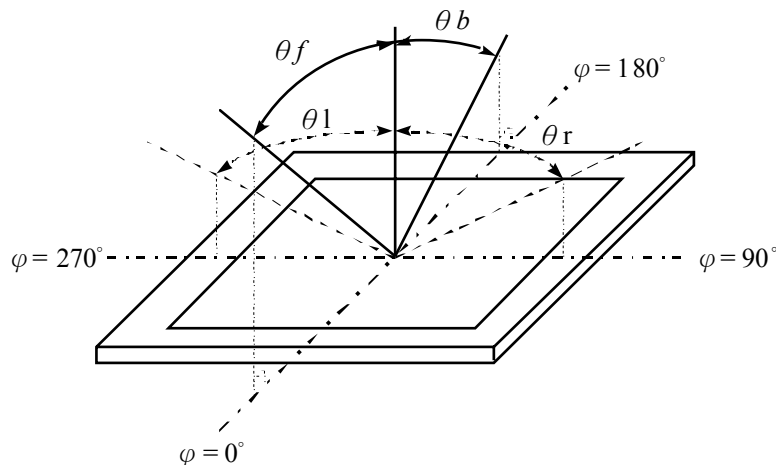
### Definition of Response Time (Tr, Tf)



### Conditions :

Operating Voltage : Vop      Viewing Angle( $\theta$  ,  $\varphi$ ) :  $0^\circ$  ,  $0^\circ$   
 Frame Frequency : 64 HZ      Driving Waveform : 1/N duty , 1/a bias

### Definition of viewing angle( $CR \geq 2$ )



## 12. Absolute Maximum Ratings

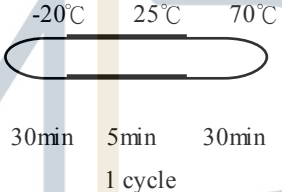
Item	Symbol	Min	Typ	Max	Unit
Operating Temperature	$T_{OP}$	-20	—	+70	°C
Storage Temperature	$T_{ST}$	-30	—	+80	°C
Input Voltage	$V_I$	$V_{SS}$	—	$V_{DD}$	V
Supply Voltage For Logic	$V_{DD}-V_{SS}$	-0.3	—	7	V
Supply Voltage For LCD	$V_{DD}-V_0$	-0.3	—	13	V

## 13. Electrical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
Supply Voltage For Logic	$V_{DD}-V_{SS}$	—	4.5	5.0	5.5	V
Supply Voltage For LCD	$V_{DD}-V_0$	$T_a=-20^{\circ}\text{C}$	—	—	5.5	V
		$T_a=25^{\circ}\text{C}$	—	4.5	—	V
		$T_a=+70^{\circ}\text{C}$	3.8	—	—	V
Input High Volt.	$V_{IH}$	—	$0.7 V_{DD}$	—	$V_{DD}$	V
Input Low Volt.	$V_{IL}$	—	$V_{SS}$	—	0.6	V
Output High Volt.	$V_{OH}$	—	3.9	—	—	V
Output Low Volt.	$V_{OL}$	—	—	—	0.4	V
Supply Current	$I_{DD}$	$V_{DD}=5\text{V}$	1.0	1.2	1.5	mA

# 15. Reliability

## Content of Reliability Test (wide temperature, -20°C ~70°C)

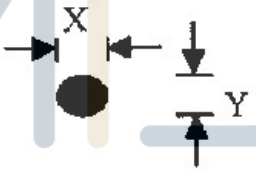
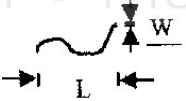
Environmental Test			
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	—
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60°C ,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C ,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation 	-20°C/70°C 10 cycles	—
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 15mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time	—

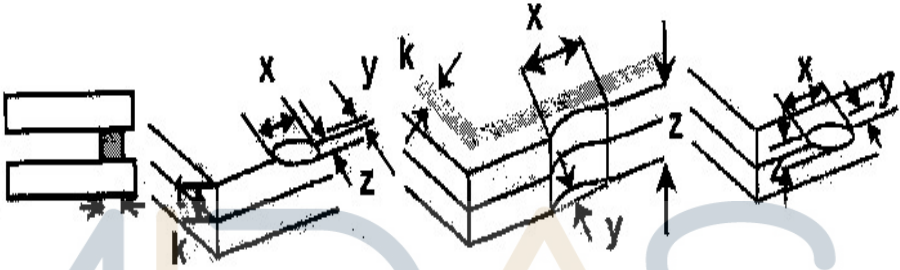
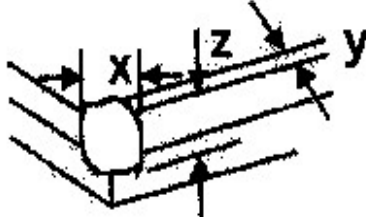
**Note1: No dew condensation to be observed.**

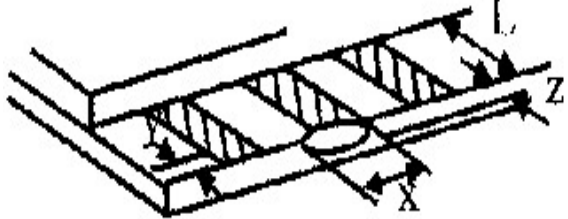

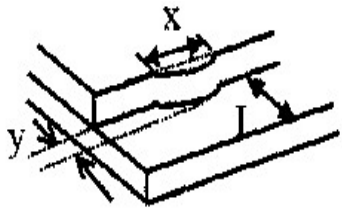
**Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.**

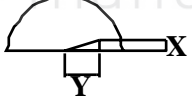
**Note3: Vibration test will be conducted to the product itself without putting it in a container.**

# 16. Inspection specification

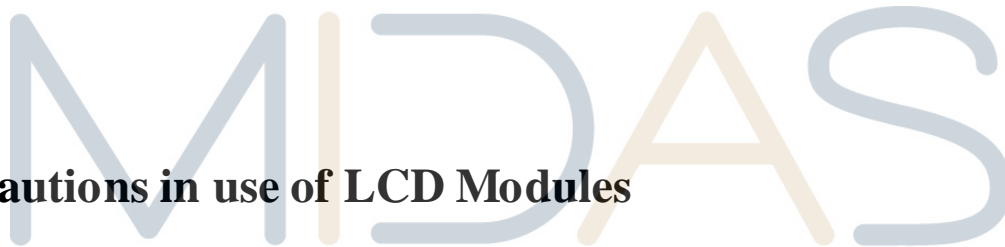
NO	Item	Criterion	AQL												
01	Electrical Testing	1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character , dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect.	0.65												
02	Black or white spots on LCD (display only)	2.1 White and black spots on display $\leq 0.25\text{mm}$ , no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm	2.5												
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type : As following drawing $\Phi = (x + y) / 2$  <table border="1" data-bbox="874 936 1353 1187"> <thead> <tr> <th>SIZE</th> <th>Acceptable Q TY</th> </tr> </thead> <tbody> <tr> <td><math>\Phi \leq 0.10</math></td> <td>Accept no dense</td> </tr> <tr> <td><math>0.10 &lt; \Phi \leq 0.20</math></td> <td>2</td> </tr> <tr> <td><math>0.20 &lt; \Phi \leq 0.25</math></td> <td>1</td> </tr> <tr> <td><math>0.25 &lt; \Phi</math></td> <td>0</td> </tr> </tbody> </table>	SIZE	Acceptable Q TY	$\Phi \leq 0.10$	Accept no dense	$0.10 < \Phi \leq 0.20$	2	$0.20 < \Phi \leq 0.25$	1	$0.25 < \Phi$	0	2.5		
		SIZE	Acceptable Q TY												
$\Phi \leq 0.10$	Accept no dense														
$0.10 < \Phi \leq 0.20$	2														
$0.20 < \Phi \leq 0.25$	1														
$0.25 < \Phi$	0														
3.2 Line type : (As following drawing)  <table border="1" data-bbox="705 1249 1353 1467"> <thead> <tr> <th>Length</th> <th>Width</th> <th>Acceptable Q TY</th> </tr> </thead> <tbody> <tr> <td>---</td> <td><math>W \leq 0.02</math></td> <td>Accept no dense</td> </tr> <tr> <td><math>L \leq 3.0</math></td> <td><math>0.02 &lt; W \leq 0.03</math></td> <td rowspan="2">2</td> </tr> <tr> <td><math>L \leq 2.5</math></td> <td><math>0.03 &lt; W \leq 0.05</math></td> </tr> <tr> <td>---</td> <td><math>0.05 &lt; W</math></td> <td>As round type</td> </tr> </tbody> </table>	Length	Width	Acceptable Q TY	---	$W \leq 0.02$	Accept no dense	$L \leq 3.0$	$0.02 < W \leq 0.03$	2	$L \leq 2.5$	$0.03 < W \leq 0.05$	---	$0.05 < W$	As round type	2.5
Length	Width	Acceptable Q TY													
---	$W \leq 0.02$	Accept no dense													
$L \leq 3.0$	$0.02 < W \leq 0.03$	2													
$L \leq 2.5$	$0.03 < W \leq 0.05$														
---	$0.05 < W$	As round type													
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction. <table border="1" data-bbox="842 1657 1353 1904"> <thead> <tr> <th>Size <math>\Phi</math></th> <th>Acceptable Q TY</th> </tr> </thead> <tbody> <tr> <td><math>\Phi \leq 0.20</math></td> <td>Accept no dense</td> </tr> <tr> <td><math>0.20 &lt; \Phi \leq 0.50</math></td> <td>3</td> </tr> <tr> <td><math>0.50 &lt; \Phi \leq 1.00</math></td> <td>2</td> </tr> <tr> <td><math>1.00 &lt; \Phi</math></td> <td>0</td> </tr> <tr> <td>Total Q TY</td> <td>3</td> </tr> </tbody> </table>	Size $\Phi$	Acceptable Q TY	$\Phi \leq 0.20$	Accept no dense	$0.20 < \Phi \leq 0.50$	3	$0.50 < \Phi \leq 1.00$	2	$1.00 < \Phi$	0	Total Q TY	3	2.5
Size $\Phi$	Acceptable Q TY														
$\Phi \leq 0.20$	Accept no dense														
$0.20 < \Phi \leq 0.50$	3														
$0.50 < \Phi \leq 1.00$	2														
$1.00 < \Phi$	0														
Total Q TY	3														

NO	Item	Criterion	AQL																		
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination																			
06	Chipped glass	<p>Symbols Define:  x: Chip length      y: Chip width      z: Chip thickness  k: Seal width      t: Glass thickness      a: LCD side length  L: Electrode pad length:</p> <p>6.1 General glass chip :  6.1.1 Chip on panel surface and crack between panels:</p>  <table border="1" data-bbox="443 1032 1356 1189"> <thead> <tr> <th>z: Chip thickness</th> <th>y: Chip width</th> <th>x: Chip length</th> </tr> </thead> <tbody> <tr> <td><math>Z \leq 1/2t</math></td> <td>Not over viewing area</td> <td><math>x \leq 1/8 a</math></td> </tr> <tr> <td><math>1/2t &lt; z \leq 2t</math></td> <td>Not exceed <math>1/3k</math></td> <td><math>x \leq 1/8 a</math></td> </tr> </tbody> </table> <p>⊙ If there are 2 or more chips, x is total length of each chip.</p> <p>6.1.2 Corner crack:</p>  <table border="1" data-bbox="443 1570 1356 1727"> <thead> <tr> <th>z: Chip thickness</th> <th>y: Chip width</th> <th>x: Chip length</th> </tr> </thead> <tbody> <tr> <td><math>Z \leq 1/2t</math></td> <td>Not over viewing area</td> <td><math>x \leq 1/8 a</math></td> </tr> <tr> <td><math>1/2t &lt; z \leq 2t</math></td> <td>Not exceed <math>1/3k</math></td> <td><math>x \leq 1/8 a</math></td> </tr> </tbody> </table> <p>⊙ If there are 2 or more chips, x is the total length of each chip.</p>	z: Chip thickness	y: Chip width	x: Chip length	$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8 a$	$1/2t < z \leq 2t$	Not exceed $1/3k$	$x \leq 1/8 a$	z: Chip thickness	y: Chip width	x: Chip length	$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8 a$	$1/2t < z \leq 2t$	Not exceed $1/3k$	$x \leq 1/8 a$	2.5
z: Chip thickness	y: Chip width	x: Chip length																			
$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8 a$																			
$1/2t < z \leq 2t$	Not exceed $1/3k$	$x \leq 1/8 a$																			
z: Chip thickness	y: Chip width	x: Chip length																			
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$1/2t < z \leq 2t$	Not exceed $1/3k$	$x \leq 1/8 a$																			

NO	Item	Criterion	AQL																
06	Glass crack	<p>Symbols :</p> <p>x: Chip length            y: Chip width            z: Chip thickness  k: Seal width            t: Glass thickness    a: LCD side length  L: Electrode pad length</p> <p>6.2 Protrusion over terminal :</p> <p>6.2.1 Chip on electrode pad :</p>  <table border="1" data-bbox="339 869 1252 952"> <tr> <td>y: Chip width</td> <td>x: Chip length</td> <td>z: Chip thickness</td> </tr> <tr> <td><math>y \leq 0.5\text{mm}</math></td> <td><math>x \leq 1/8a</math></td> <td><math>0 &lt; z \leq t</math></td> </tr> </table> <p>6.2.2 Non-conductive portion:</p>  <table border="1" data-bbox="411 1276 1252 1359"> <tr> <td>y: Chip width</td> <td>x: Chip length</td> <td>z: Chip thickness</td> </tr> <tr> <td><math>y \leq L</math></td> <td><math>x \leq 1/8a</math></td> <td><math>0 &lt; z \leq t</math></td> </tr> </table> <ul style="list-style-type: none"> <li>⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.</li> <li>⊙ If the product will be heat sealed by the customer, the alignment mark not be damaged.</li> </ul> <p>6.2.3 Substrate protuberance and internal crack.</p>  <table border="1" data-bbox="746 1601 1252 1684"> <tr> <td>y: width</td> <td>x: length</td> </tr> <tr> <td><math>y \leq 1/3L</math></td> <td><math>x \leq a</math></td> </tr> </table>	y: Chip width	x: Chip length	z: Chip thickness	$y \leq 0.5\text{mm}$	$x \leq 1/8a$	$0 < z \leq t$	y: Chip width	x: Chip length	z: Chip thickness	$y \leq L$	$x \leq 1/8a$	$0 < z \leq t$	y: width	x: length	$y \leq 1/3L$	$x \leq a$	2.5
y: Chip width	x: Chip length	z: Chip thickness																	
$y \leq 0.5\text{mm}$	$x \leq 1/8a$	$0 < z \leq t$																	
y: Chip width	x: Chip length	z: Chip thickness																	
$y \leq L$	$x \leq 1/8a$	$0 < z \leq t$																	
y: width	x: length																		
$y \leq 1/3L$	$x \leq a$																		

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination. 9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB · COB	10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 10.9 The Scraping testing standard for Copper Coating of PCB  $X * Y \leq 2\text{mm}^2$	2.5 2.5 0.65 2.5 0.65 0.65 2.5 2.5
11	Soldering	11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB.	2.5 2.5 2.5 0.65

NO	Item	Criterion	AQL
12	General appearance	12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.	2.5
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever.	2.5
		12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.	2.5
		12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging specification sheet.	0.65
		12.11 Product dimension and structure must conform to product specification sheet.	0.65



## 17. Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3) Don't disassemble the LCM.
- (4) Don't operate it above the absolute maximum rating.
- (5) Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.



# 18. Material List of Components for RoHs

1. T äæ Å[ { ] [ ] ^} • Ltd. hereby declares that all of or part of products, including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A : The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm
Above limited value is set up according to RoHS.						

## 2.Process for RoHS requirement :

- (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :  
 Reflow : 250°C ,30 seconds Max. ;  
 Connector soldering wave or hand soldering : 320°C , 10 seconds max.
- (3) Temp. curve of reflow, max. Temp. : 235±5°C ;  
 Recommended customer's soldering temp. of connector : 280°C , 3 seconds.